



Product Change Notification

113305 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 113305 - 00
Change Title: Intel® Server System R1304EP2SHFN
PCN 113305-00, Product Design
Add Mylar on top of Front Panel and add
plastic block under Front Panel board
Date of Publication: October 19, 2014

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

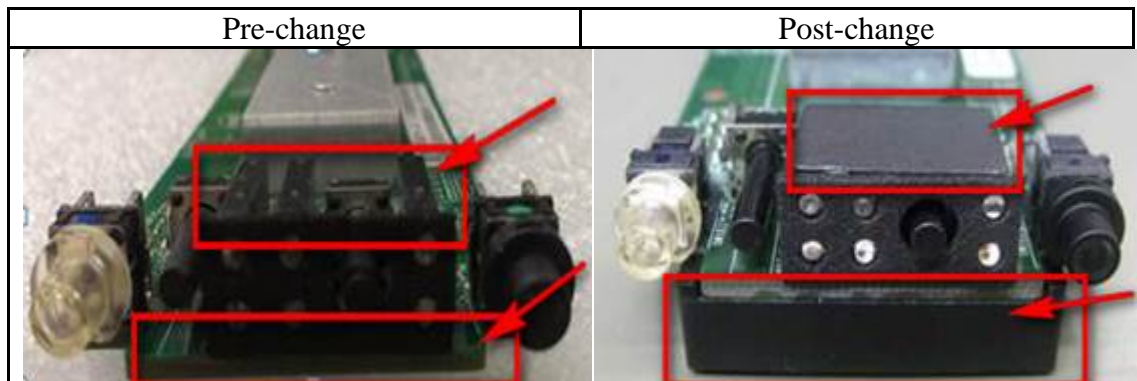
Date Customer Must be Ready to Receive Post-Conversion Material *:	November 3, 2014
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** Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server System R1304EP2SHFN:

Add a mylar on the top of the front panel board and add a plastic block for the front end under the front panel to hold parts more securely. See the images below:



Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes. Customers may need to validate the function and feature changes once the post-change system is available.

Products Affected / Intel Ordering Codes:

CORE SKU			
Product Code	MM#	Pre Change TA	Post Change TA
R1304EP2SHFN	919764	G60495-002	G60495-003

PCN Revision History:

Date of Revision:

October 19, 2014

Revision Number:

00

Reason:

Originally Published PCN